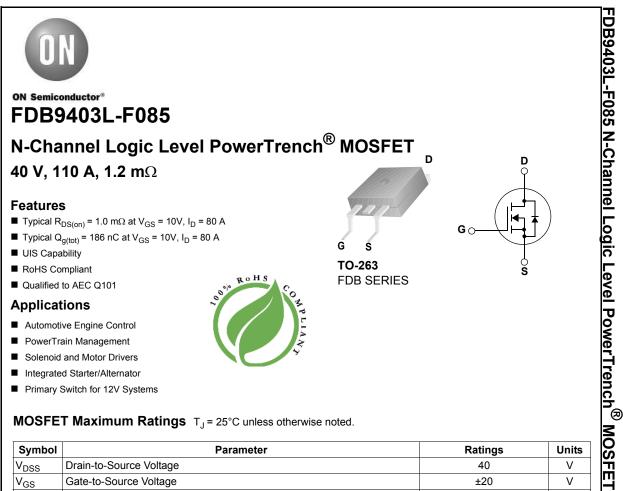
**ON Semiconductor** 

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# MOSFET Maximum Ratings T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-to-Source Voltage		40	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	110	
D	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	634	mJ
	Power Dissipation		333	W
P <sub>D</sub>	Derate Above 25°C		2.22	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.45	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W

### Notes:

1: Current is limited by bondwire configuration.

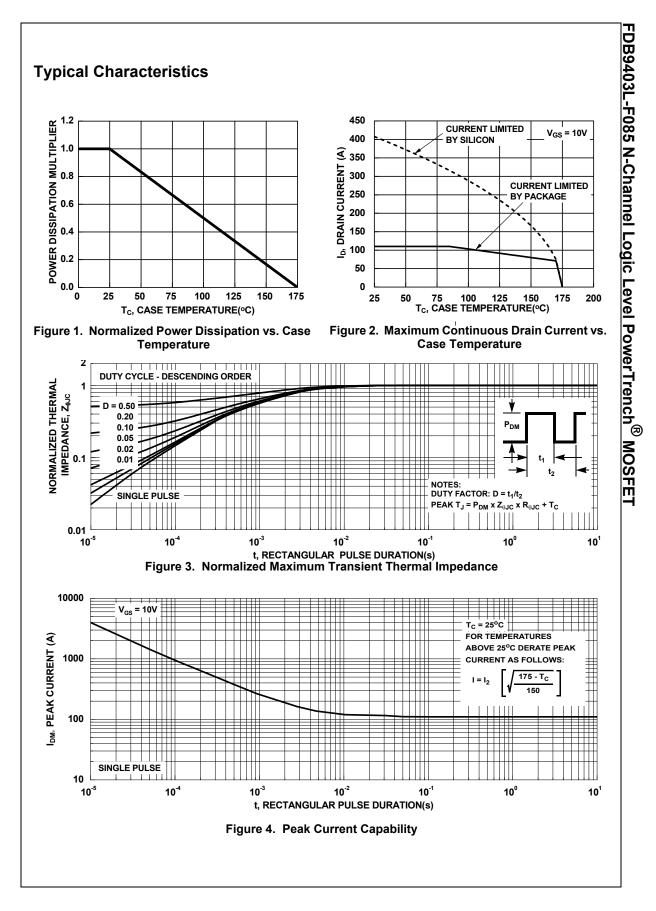
2: Starting T<sub>J</sub> = 25°C, L = 0.3mH,  $I_{AS}$  = 65A,  $V_{DD}$  = 40V during inductor charging and  $V_{DD}$  = 0V during time in avalanche. 3:  $R_{0,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder moduling surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

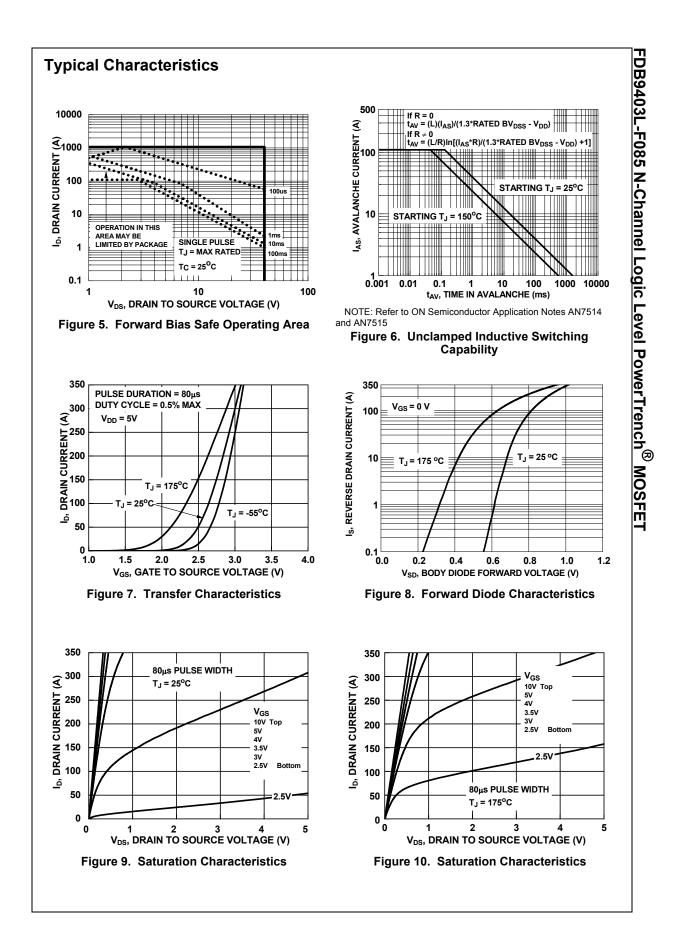
# Package Marking and Ordering Information

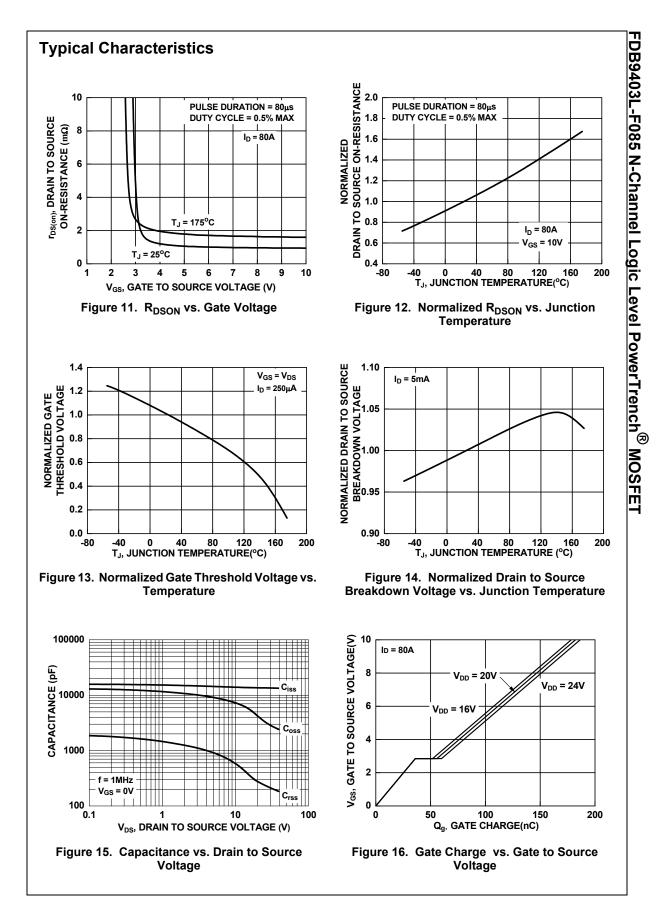
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB9403L	FDB9403L-F085	D2-PAK(TO-263)	330mm	24mm	800 units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA,	V <sub>GS</sub> =0V	40	-	-	V
		$V_{DS}$ =40V, $T_J$ =25°C		-	-	1	μA
IDSS	Drain-to-Source Leakage Current	V <sub>GS</sub> = 0V	$T_{\rm J} = 175^{\rm o}C \ ({\rm Note} \ 4)$	-	-	3	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		1.0	1.8	3.0	V
		$I_D = 80A, V_{GS} = 4.5V$		-	1.2	1.6	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = 80A,	$T_J = 25^{\circ}C$	-	1.0	1.2	mΩ
		V <sub>GS</sub> = 10V	$T_{\rm J}$ = 175°C (Note 4)	-	1.7	2.0	mΩ
Dynami	ic Characteristics						
C <sub>iss</sub>	Input Capacitance			-	13500	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 20 V,$	$V_{GS} = 0V,$	-	4300	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz	-	-	280	-	pF
Rg	Gate Resistance	f = 1MHz		-	2.7	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge at 10V	V <sub>GS</sub> = 0 to 1	0V V <sub>DD</sub> = 32V	-	186	245	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS}$ = 0 to 2	$I_D = 80A$	-	23	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge			-	33	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	22	-	nC
Switchi	ng Characteristics						
t <sub>on</sub>	Turn-On Time		_	-	-	156	ns
	Turn-On Delay			-	16	-	ns
t <sub>d(on)</sub>	Rise Time	$V_{DD} = 20V, I_D = 80A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		-	63	-	ns
t <sub>r</sub>				-	142	-	ns
t <sub>r</sub> t <sub>d(off)</sub>	Turn-Off Delay	$v_{GS} = 100,$	+			-	ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off Delay Fall Time	v <sub>GS</sub> = 100,		-	107		
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off Delay	v <sub>GS</sub> = 10v,		-	-	399	ns
$t_r$ $t_{d(off)}$ $t_f$ $t_{off}$	Turn-Off Delay Fall Time	V <sub>GS</sub> = 10V,	-	-	-	399	ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub> Drain-S	Turn-Off Delay Fall Time Turn-Off Time Fource Diode Characteristics	I <sub>SD</sub> =80A, V		-	-	1.25	V
$t_r$ $t_{d(off)}$ $t_f$ $t_{off}$ <b>Drain-S</b> $V_{SD}$	Turn-Off Delay   Fall Time   Turn-Off Time   ource Diode Characteristics   Source-to-Drain Diode Voltage	I <sub>SD</sub> =80A, V I <sub>SD</sub> = 40A, V	/ <sub>GS</sub> = 0V	-	-	1.25 1.2	
$t_r$ $t_{d(off)}$ $t_f$ $t_{off}$	Turn-Off Delay Fall Time Turn-Off Time Fource Diode Characteristics	I <sub>SD</sub> =80A, V I <sub>SD</sub> = 40A, V			-	1.25	V

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